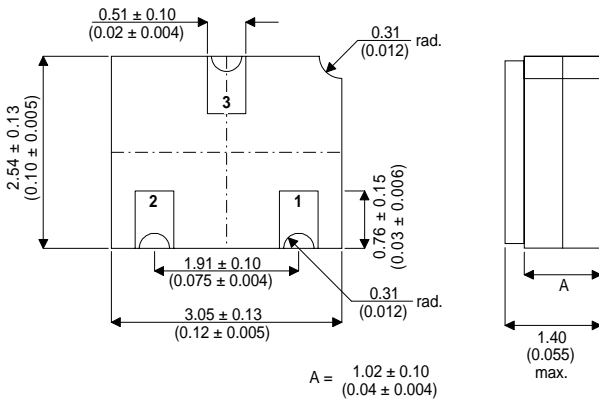


MECHANICAL DATA

Dimensions in mm (inches)



**SOT23 CERAMIC
(LCC1 PACKAGE)**

Underside View

PAD 1 – Base PAD 2 – Emitter PAD 3 – Collector

**GENERAL PURPOSE
NPN TRANSISTOR
IN A HERMETICALLY SEALED
CERAMIC SURFACE MOUNT
PACKAGE**

FEATURES

- GENERAL PURPOSE NPN TRANSISTOR
- HERMETIC CERAMIC SURFACE MOUNT PACKAGE
- CECC SCREENING OPTIONS

ABSOLUTE MAXIMUM RATINGS (T_{case} = 25°C unless otherwise stated)

V _{CBO}	Collector – Base Voltage	300V
V _{CEO}	Collector – Emitter Voltage	300V
V _{EBO}	Emitter – Base Voltage	6V
I _C	Continuous Collector Current	500mA
P _{tot}	Power Dissipation @ T _{amb} = 25°C	429mW
	@ T _{case} = 25°C	1.8W
T _j T _{stg}	Operating and Storage Temperature	-55 to 175°C

THERMAL CHARACTERISTICS

Parameter	Max.	Unit
R _{th(j-amb)} Thermal Resistance Junction to Ambient	350	°C/W

ELECTRICAL CHARACTERISTICS ($T_C = 25^\circ\text{C}$ unless otherwise stated)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit	
$V_{(BR)CBO}$	Collector – Base Breakdown Voltage $I_C = 100\mu\text{A}$ $I_E = 0$	300			V	
$V_{(BR)CEO}$	Collector - Emitter Breakdown Voltage $I_C = 1\text{mA}$ $I_B = 0^*$	300			V	
$V_{(BR)EBO}$	Emitter – Base Breakdown Voltage $I_E = 100\mu\text{A}$ $I_C = 0$	6			V	
I_{CBO}	Collector Cut-off Current $V_{CB} = 200\text{V}$ $I_E = 0$			0.1	μA	
I_{EBO}	Emitter Cut-off Current $V_{EB} = 6\text{V}$ $I_C = 0$			0.1	μA	
				—		
$V_{CE(sat)}$	Collector – Emitter Saturation Voltage $I_C = 20\text{mA}$ $I_B = 2\text{mA}$			0.5	V	
$V_{BE(sat)}$	Emitter Saturation Voltage $I_C = 20\text{mA}$ $I_B = 2\text{mA}$			0.9		
h_{FE}	Static Forward Current Transfer Ratio $I_C = 1\text{mA}$ $V_{CE} = 10\text{V}^*$	25			—	
		$I_C = 10\text{mA}$ $V_{CE} = 10\text{V}^*$	40			
		$I_C = 30\text{mA}$ $V_{CE} = 10\text{V}^*$	40			
f_T	Transition Frequency $V_{CE} = 20\text{V}$ $I_C = 10\text{mA}$ $f = 20\text{MHz}$	50			MHz	
C_{obo}	Output Capacitance $V_{CB} = 20\text{V}$ $I_E = 0$ $f = 1\text{MHz}$		6		pF	

* Pulse Test: Pulse Width = 200 μs , Duty Cycle $\leq 2\%$.